

WEST Search History

DATE: Friday, August 22, 2003

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DB=USPT,PGPB,JPAB,EPAB,DWPI,TDBD; THES=ASSIGNEE; PLUR=YES; OP=AND			
L7	L6 and (pad or applicator or absorbent or adsorbent)	16	L7
L6	L5 and (voltage or potential)	109	L6
L5	plating near25 deplating	161	L5
L4	L3 and (pad or applicator or absorbent or adsorbent)	55	L4
L3	L2 and L1	278	L3
L2	(voltage or potential) near25 ((deplat\$10 or remov\$10 or dissolv\$10) near3 (metal or material or layer or film or coating or copper))	6946	L2
L1	((first or initial or primary or starting or beginning) near3 (voltage or potential)) near25 (deposit\$10 or plat\$10 or electroplat\$10 or electrochem\$10)	6568	L1

END OF SEARCH HISTORY

Patent Assignment Abstract of Title

Total Assignments: 1

Applicati n #: 09961134 Filing Dt: 09/21/2001

Patent #: NONE

Issue Dt:

PCT #: NONE

Inventors: Stan Tsai, Shijian Li

Publication #: 20030057097

Pub Dt: 03/27/200

Title: Method and apparatus for forming metal layers

Assignment: 1

Reel/Frame: <u>012202/0307</u> Received:

Recorded: 09/21/2001

Mailed: 12/03/2001 Pages:

Conveyance: ASSIGNMENT OF ASSIGNORS INTEREST (SEE DOCUMENT FOR DETAILS).

Exec Dt: 09/21/2001

Exec Dt: 09/21/2001

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Search Results as of: 8/22/2003 10:55:52 A.M.

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